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October 2001

IGBT

SGF80N60UF

Ultra-Fast IGBT

General Description

Fairchild's Insulated Gate Bipolar Transistor(IGBT) UF series provides low conduction and switching losses. UF series is designed for the applications such as motor control and general inverters where High Speed Switching is required.

Features

- High Speed Switching
- Low Saturation Voltage : $V_{CE(sat)} = 2.1 \text{ V } @ I_C = 40 \text{A}$
- High Input Impedance

Application

AC & DC Motor controls, General Purpose Inverters, Robotics, Servo Controls





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGF80N60UF	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ $T_C = 25^{\circ}C$	80	А
I _C	Collector Current	@ T _C = 100°C	40	Α
I _{CM (1)}	Pulsed Collector Current	-	220	Α
P _D	Maximum Power Dissipation	@ $T_C = 25^{\circ}C$	110	W
	Maximum Power Dissipation	@ T _C = 100°C	45	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I_{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Cha	racteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 40$ mA, $V_{CE} = V_{GE}$	3.5	4.5	6.5	V
	Collector to Emitter	$I_C = 40A$, $V_{GE} = 15V$		2.1	2.6	V
V _{CE(sat)}	Saturation Voltage	$I_C = 80A$, $V_{GE} = 15V$		2.6		V
•	c Characteristics		1	0700		
C _{ies}	Input Capacitance	$V_{CE} = 30V_{V_{GE}} = 0V_{V_{GE}}$		2790		pF
C _{oes} C _{res}	Output Capacitance Reverse Transfer Capacitance	f = 1MHz		350 100		pF pF
	ng Characteristics Turn-On Delay Time			23		ns
t _{d(on)}	•					
t _r	Rise Time			50	120	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_C = 40\text{A},$		90	130	ns
t _f	Fall Time	$R_G = 5\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$		50	150	ns
E _{on}	Turn-On Switching Loss	inductive Load, 1 _C = 25 C		570 590		uJ uJ
E _{off}	Turn-Off Switching Loss	_				
E _{ts}	Total Switching Loss			1160	1500	uJ
t _{d(on)}	Turn-On Delay Time Rise Time	_		30 55		ns
t _r		V_{CC} = 300 V, I_{C} = 40A, R_{G} = 5 Ω , V_{GE} = 15V, Inductive Load, T_{C} = 125°C		150	200	ns
t _{d(off)}	Turn-Off Delay Time Fall Time			160	250	ns
t _f □	Turn- On Switching Loss			630	250	ns uJ
	<u> </u>			940		
⊏on ⊏						uJ
E _{off}	Turn- Off Switching Loss	1		1500	2000	11.1
E _{off} E _{ts}	Total Switching Loss			1580	2000	uJ nC
E _{off} E _{ts} Q _g	Total Switching Loss Total Gate Charge	V _{CE} = 300 V, I _C = 40A,		175	250	nC
E _{off} E _{ts} Q _g Q _{ge}	Total Switching Loss Total Gate Charge Gate-Emitter Charge	V _{CE} = 300 V, I _C = 40A, V _{GE} = 15V		175 25	250 40	nC nC
$\begin{aligned} & E_{on} \\ & E_{off} \\ & E_{ts} \\ & Q_{g} \\ & Q_{ge} \\ & Q_{gc} \\ & L_{e} \end{aligned}$	Total Switching Loss Total Gate Charge			175	250	nC

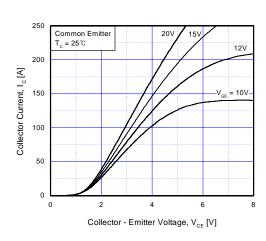


Fig 1. Typical Output Characteristics

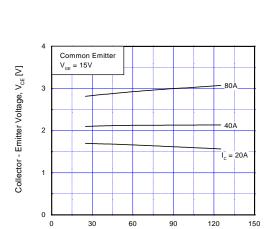


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

Case Temperature, T_c [°C]

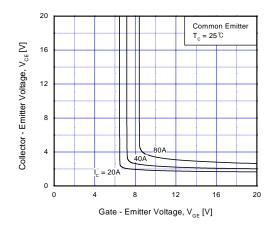


Fig 5. Saturation Voltage vs. V_{GE}

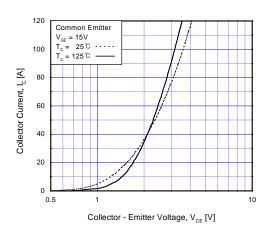


Fig 2. Typical Saturation Voltage Characteristics

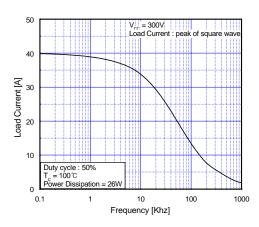


Fig 4. Load Current vs. Frequency

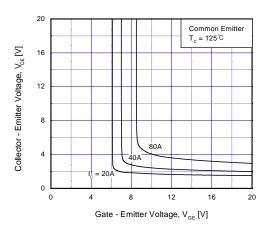
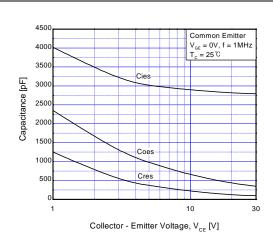


Fig 6. Saturation Voltage vs. V_{GE}

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Common Emitter $V_{cc} = 300V, V_{cg} = \pm 15V$ $V_{cc} = 40A$ $V_{cc} = 25\,^\circ\text{C}$ $V_{cc} = 125\,^\circ\text{C}$ $V_{$

Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance

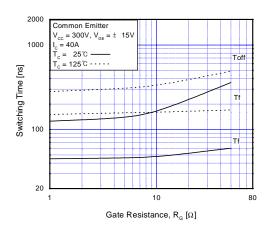
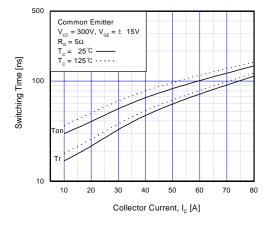




Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



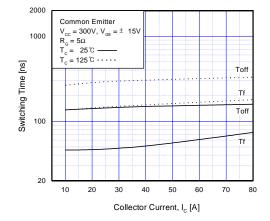


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs.
Collector Current

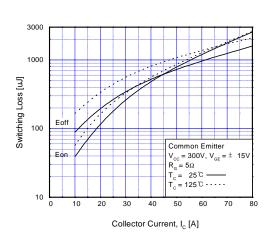
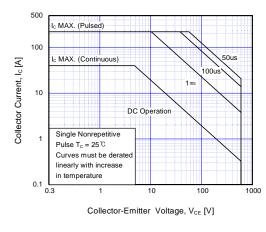


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



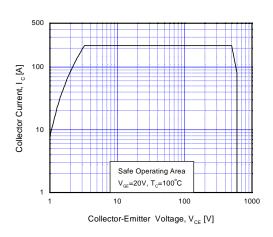


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

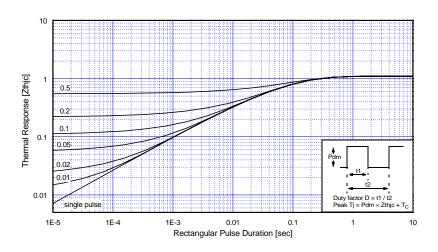
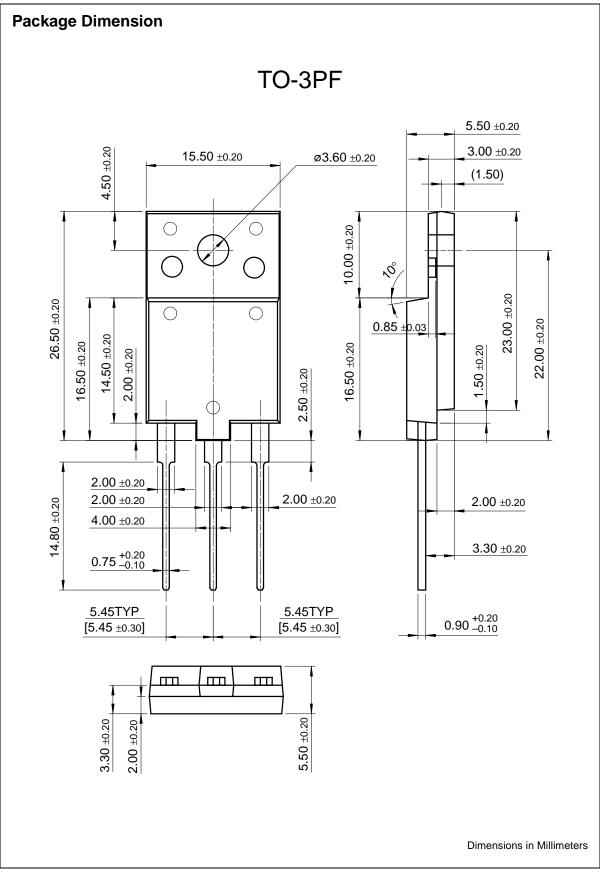


Fig 17. Transient Thermal Impedance of IGBT

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